

## **SymAsym - “The Sequel”, AAK’s PCB Assembly Instructions**

This document is intended to provide all the information necessary to build my PCB. I’ll post the latest schematic, BOM, step-by-step detailed assembly instructions that hopefully will reduce the chance of making a mistake, procedures for matching transistors, picture illustrations, and testing. I also would like to explore the different configurations the circuit provides to see how it correlates with sound quality. I’ll provide schematics illustrating the different configurations as we move along.

I’ll divide the instructions into different categories starting with assembly tools.

### **Assembly Tools:**

1. Needle nose pliers for bending leads to secure components to the board before soldering.
2. Fine tip wire cutter to cut component leads after their soldered to the board.
3. Soldering gun of a least 40 to 60 watts. If the temperature is controllable set it to 700F for small signal transistors, resistors, small caps, rectifiers, and output transistors. 800F for soldering the PS caps, terminals, and fuse holders.
4. Magnifying glass to make sure there’s no shorts caused by solder slobber.
5. Alcohol and tooth brush to remove soldering flux from the board.
6. A multimeter, DVM, to measure resistance, voltage, and setting quiescent current (Iq). It should be able to measure hFE for matching small signal transistors.
7. An oscilloscope would be nice but not necessary. If no mistakes are made most likely you wont need one.

### **Assembly Tips:**

1. Check each component for the correct value before inserting them into the board. Check the package for the correct part value to make sure the right component was sent. Use a DVM to check resistor values when in doubt.
2. Check to make sure the components are inserted in the correct position.
3. Check polarized components, like capacitors, diodes, zener diodes, and LEDS, are inserted with the correct orientation. Refer to the Assembly Instructions section for additional information.
4. Bend leads away from adjacent pads when securing components to the board to help prevent shorting when soldering.
5. Don’t over solder especially in the amplifier section. Use just enough solder to cover the pads.
6. Be careful not to overheat the small signal transistors. Set the soldering gun to about 700F and quickly solder the transistor leads to the pad.
7. Solder only a few components at a time. Trying to solder around to many leads makes it more difficult to solder and could result in poor solder connections and shorts.
8. Take your time don’t rush the assembly.

## Assembly Instructions:

1. Start the assembly by inserting the resistors first. I left R5, R6, and R7 for later since they're standing, I like keeping the board as flat as possible to help keep the components in place while soldering.
2. Insert the non-polarized capacitors. These are the small Wima caps including C7, and C8, and Mica caps C15-C19.
3. Insert the small-polarized capacitors. Verify that each capacitors positive lead is inserted into the pad hole with '+' labeled next to it.
4. Insert LEDS. Insert the longer of the two leads (anode) into the pad hole with a circle labeled around it.
5. Insert the Zener Diodes, Zd1, Zd2, and Zd3 note the correct orientation labeled on the board.
6. Insert the small signal transistors (SST) including matched pairs Q1&Q2, Q3&Q4, Q5&Q6, Q9&Q12, and Q10&Q11. If you plan on mounting the drivers Q20&Q21 to the main heat sink refer to number 10.
7. Insert R5, R6, R7, rectifiers D1-D4, terminals T1-T5, fuse holders, and large PS caps C3-C6. I like placing R7 underneath the board to provide additional clearance around ground terminal T4. Set solder gun to about 800F when soldering terminals, fuse holders, and large caps. Solder the top and bottom of each terminal and fuse holder for added strength. The rectifier's metal tabs should face inward towards the AC terminals. For the large PS caps insert the positive lead in the pad hole with '+' labeled next to it. For the fuse holders make sure the tabs face outward.
8. Jumper J1 to J2 with a 22 to 26-gauge 1.6" (41mm) jacketed wire. The J1 pad is located right below the adjustable pot R36, and between Q8, and R29. The J2 pad is located between R32, R30 and L3. Place and solder the jumper underneath the board.
9. Solder to each Q17 (BD139) pin a 2" (50mm) jacketed wire so that it can reach far enough to mount onto Q22 for thermal sensing. I like trimming the BD139's leads about 0.25" before soldering the wires to them, and then insulating the solder connections using 1/16" heat shrink tubing about 5/8" in length to help prevent the pins from shorting. Before soldering the wires to the board trim the wires to the correct length by first turning the board upside down placing the BD139's backside up over where about Q22's mounting hole would be. Lay the wires flat over the board so they don't overlap each other, then bend the leads towards the pads at a 90-degree angle and trim the wires even. Now strip the ends of the wires about 3/16" then insert the ends into the pads and solder from underneath. You may need to pull the wires out slightly to make a good solder connection.
10. Insert drivers Q20&Q21. Here you have two options. Either insert the drivers from the top side, and use the small heat sink listed on the BOM, or from underneath to mount the drivers to the main heat sink (MHS). I prefer the former. If you select the later, first mount the drivers on the MHS allowing enough clearance between the mounting hole and board edge so that you can easily access the mounting screw. Then holding the board above the drivers align the pins with each pad. Use 3/8" standoffs at each corner of the board where the mounting holes are to provide an even spacing between the board and the main heat sink. Then tack on the pins to the pads with a small amount of solder from the topside to hold the drivers in place. Then

remove the board and solder the drivers from underneath. I'd suggest leaving out Q18&Q19 to provide some extra wiggle room for the solder tip when tacking on the drivers.

11. Next output transistors Q22, Q23, Q24 and Q25, and mounting thermal tracking transistor Q17 to Q22. First mount the output transistors (OT) to the MHS, and then holding the board above the OT align the pins with each pad. Use standoffs at each corner of the board before soldering to provide an even spacing between the board and the main heat sink. Then solder the OT pins to the pads from the topside, and then remove the board and solder from underneath. When remounting the OT to the MHS mount Q17 to Q22.
12. Lastly attach a single ground wire from one of the ground pads located near C7 and C8 to the MHS.